

Technical support: tpmg@niccomp.com

Double Layer Capacitors

PN: NEX_ series & NED_ series



NEXC SMT Reflow Soldering



NEXA / NEXG NEXS / NEXT Low Profile Radial LDD



NEXM Molded Radial LDD



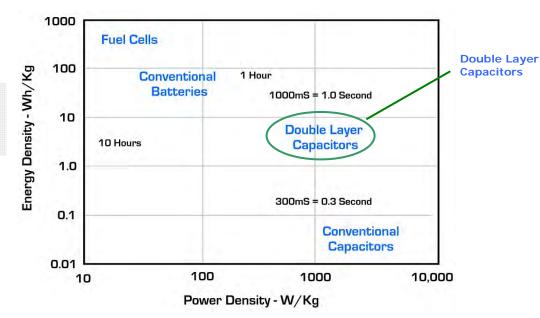
NEDL NEDR Large Case Radial LDD

Double Layer Capacitors

Also known as super capacitors, gold capacitors, ultra capacitors and farad capacitors All belong to the family of electro-chemical double layer capacitors abbreviated **EDLCs**

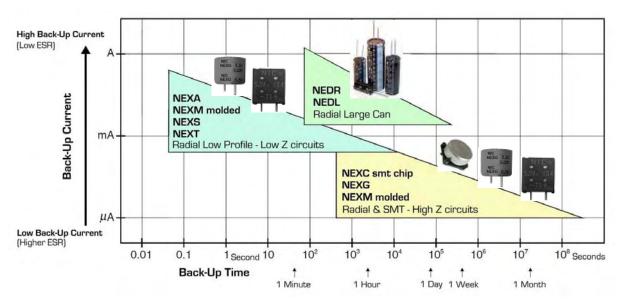
Feature high capacitance value (Farad) for energy storage, voltage hold-up and battery back-up applications. Double layer capacitors bridge the gap (see graph below) between conventional batteries and conventional capacitors. EDLCs store and deliver temporary (or momentary) energy to electronic circuits in wide range of low voltage (2 ~ 12VDC) circuit applications.





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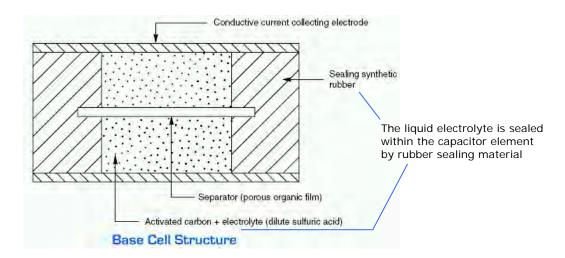
Selection Guide: Series - Type

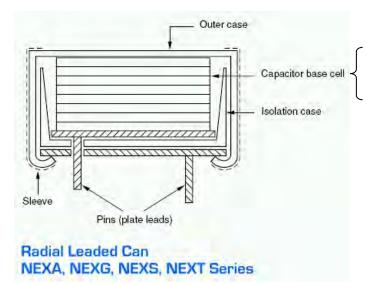


NIC Series	Туре	Size (mm)	Capacitance	Voltage
NEXC -25°C ~ +70°C	SMT Chip	10.5 Ø x 5.5 height 10.5 Ø x 8.5 height 10.7 Ø x 5.5 height 16 Ø x 9.5 height 21 Ø x 10.5 height	0.047F ~ 1.0F (47,000 μF ~ 1,000,000 μF)	3.5VDC 5.5VDC
NEXM -25°C ~ +70°C	Radial LDD Molded Case	5mm LS 10.5 x 11.5 x 5.0 10.5 x 11.5 x 6.5	0.01F ~ 0.22F (10,000μF ~ 220,000μF)	3.5VDC 6.5VDC
NEDL -25°C ~ +70°C NEDR -25°C ~ +60°C -25°C ~ +70°C	Radial LDD Large Can	10 Ø x 35 height 12.5 Ø x 25 height 12.5 Ø x 35 height 16 Ø x 35.5 height 18 Ø x 40 height 18 Ø x 50 height 22 Ø x 50 height	10F ~ 100F	2.5VDC 2.7VDC
NEXA NEXG NEXS -25°C ~ +70°C NEXT -40°C ~ +85°C	Radial LDD Low Profile	11 Ø x 5.5 / 6.5 / 8.5 13 Ø x 8.5 / 9 14.5 Ø x 12 / 18 16 Ø x 15.5 / 25 16.5 Ø x 8.5 / 13 / 19 21.5 Ø x 13 / 15.5 / 19 28.5 Ø x 16.5 / 14 / 19 / 22 / 25.5 / 31.5 / 38 36.5 Ø x 15 / 16.5 / 27.5 44.5 Ø x 17 / 18.5 / 28.5 / 60	0.01F ~ 5.6F (10,000μF ~ 5,600,000μF)	5.5VDC 11VDC 12VDC

NEX_ Series Construction:

Double Layer Cell (~ 1.2VDC breakdown)

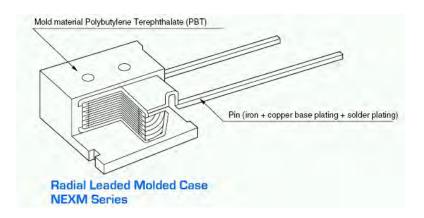




Multiple cells are connected in series, to increase the voltage rating of the capacitor



NEXT





NEXM



NEXC

PN: NEX_ series & NED_ series



Precautions for Use:

Circuit Design

Voltage:

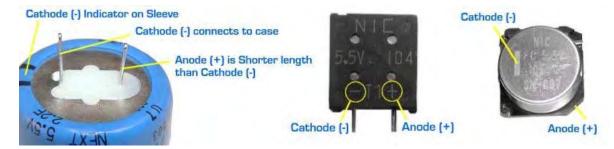
- o Only direct current (VDC) should be applied to double layer capacitors
- o Ensure that the maximum operating voltage does not exceed the rated voltage (VDC)
- Application of a voltage exceeding the maximum operating voltage may deteriorate performance and damage the component.

Polarity:

Double layer capacitors are polarized (anode + terminal and cathode – terminal). Please assure correct polarity when installing (or placing) component during PCB assembly.

Components have polarity indicators as follows:

- o NEXC SMT; Anode (+) notch in base-plate and top of can Cathode (-) indicator (See Image)
- o NEXM Molded case radial leaded; Polarity (+ & -) indicators on case (See Image)
- o NEXA, NEXG, NEXS, NEXT Radial leaded; Cathode (-) indicators on sleeve and case (See Image)



Equivalent Series Resistance (ESR):

ESR of double layer capacitors is relatively high. Do not use double layer capacitors in supply voltage smoothing circuits, such as output filter of power supply circuits

Parallel connection of multiple double layer capacitors is possible; please assure the voltage applied to each capacitor does not exceed the maximum operating voltage (VDC).

For series connection of multiple double layer capacitors, please take measures to ensure voltage is evenly distributed to all capacitors and the voltage applied to each capacitor does not exceed the maximum operating voltage (VDC).

Mounting - Soldering

- a. **All radial leaded versions** of double layer capacitors **cannot withstand exposure** to reflow soldering heat. Only NEXC series can be used in reflow soldering process.
- b. When using flow wave soldering process, ensure that the soldering temperature is ≤260 °C and soldering duration does not exceed 10 seconds
- c. For soldering with a soldering rod, select a soldering rod with a capacity of \sim 30W and ensure that the tip temperature <400°C and soldering duration is less than 3 seconds
- d. Excessive soldering heat may increase the equivalent series resistance (ESR) of the capacitor
- d. Do not bend, deform or file capacitor terminals and take measures to prevent mechanical impact damage to terminals. Impact to terminals may cause damage to plating and result in poor soldering.
- e. All capacitors, including those with insulation sleeving should not contact adjacent components nor contact assembly case
- f. Use in the vicinity of a heating element (coil, power transistor, resistor, etc.) may heat the capacitor itself and considerably shorten its service life

PN: NEX_ series & NED_ series



Precautions for Use:

Residual Charge

Take precautions, as some residual potential (applied during manufacturing test) may be present on double layer capacitors as received. Voltage recovery over time may result in residual charge on component after time in transit and on shelf. Please take measures to avoid damage to other components (i.e. semiconductors) during PC assembly.

Environment

Double layer capacitors cannot be used in an acidic or alkaline atmospheres or liquids

Washing

- Do not wash double layer capacitors, except NEXM series, without reviewing washing conditions with NIC technical support [tpmg@niccomp.com]. Special washing-resistant versions may be available.
- Drying after washing of NEXM series, should be performed within the maximum operating temperature range [< +70°C].

Storage

- a. Storage Conditions:
 - o Indoors
 - Temperature: $+5^{\circ}C \sim +35^{\circ}C (41^{\circ}F \sim 95^{\circ}F)$ 0
 - Relative humidity: 40 to 75%
- b. Avoid exposing the components to direct sunlight for extended periods. Doing so may cause deterioration or discoloration of the insulation sleeving
- c. Do not store in an alkaline or acidic atmosphere.

Disassembly & Disposal

- The capacitor electrolyte contains a trace amount of dilute sulfuric acid.
 Avoid contact as may have a harmful effect
- o Do not use incineration for disposal. Instead, dispose of capacitor as industrial waste

PN: NEX_ series & NED_ series

Component Selection Guide

If backup current requirement is 1 mA or greater

NEXA, NEXM, NEXS, NEXT, NEDL and NEDR series are suggested

See discharge characteristics in Appendix "A"

An approximate backup time can be calculated from the following expression:

C: Double layer capacitor capacitance (Farad)

VO: Voltage charged in double layer capacitor (VDC)

Vdrop: Voltage drop by DC resistance with double layer capacitor (VDC)

V1: Minimum required voltage for backup circuit (VDC)

I : Backup current (Amp)

The voltage drop is determined by the DC resistance of the capacitor and backup current Vdrop (VDC) = DCR * I ... $DCR = \Omega \& I = A$

Example #1:

1.0F 5.5VDC, DCR = 1.1Ω , NIC PN: NEXA105Z5.5V44.5FX18.5F

- Circuit Back-up Current; I = 1000uA (1mA)
- o Vdrop = 0.0011
- o V0= 5.0VDC
- 0 V0 = 3.0VDC 0 V1 = 3.3VDC

Back-up Time (T) = 1699 seconds (28 minutes)

Example #2:

1.0F 5.5VDC, DCR = 1.1Ω , NIC PN: NEXA105Z5.5V44.5FX18.5F

- o Circuit Back-up Current; I = 5000uA (5mA)
- o Vdrop = 0.00011
- o V0= 5.0VDC
- \circ V1 = 3.3VDC

Back-up Time (T) = 339 seconds (5.65 minutes)

If backup current requirement is less than 1 mA; NEXC, NEXG, NEXM series are suggested

An approximate backup time can be calculated from constant resistance discharge characteristics obtained by converting the back-up current requirement to a constant resistance load

See discharge characteristics in Appendix "A"

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PN: NEX_ series & NED_ series

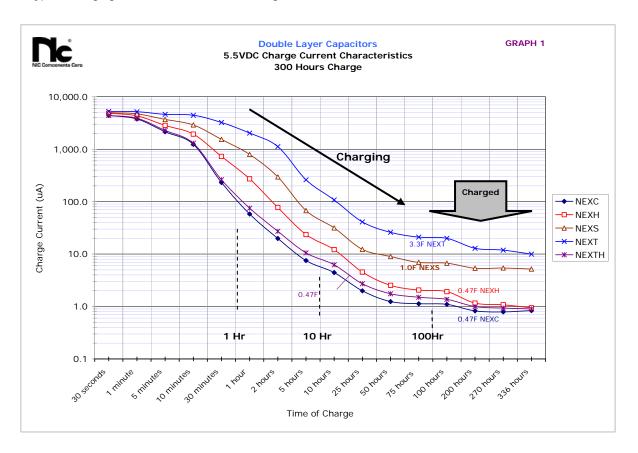
Explanation of Characteristics Terms

1.0 Charging Time & Current

Double layer capacitors require **much longer time to charge** than conventional capacitors.

For example; conventional aluminum or tantalum electrolytic capacitors charge, to the applied voltage (VDC), within a relatively short period of time (typically within seconds or minutes, depending upon Capacitance-Voltage). Leakage current characteristics for aluminum or tantalum electrolytic capacitors is usually specified in micro-Amperes (uA) after one or two minutes of charging (LC = 0.01CV after 2 minutes).

Double layer capacitors require **many hours to fully charge (100+** Hours), so the typical method of measure leakage current is not applicable with respect to double layer capacitors. Most of the current flowing into a double layer capacitor after 30 minutes is charging current rather then leakage current. Typical charging currents after 1 hour of charge, can be between 100uA ~ 3mA (GRAPH 1)

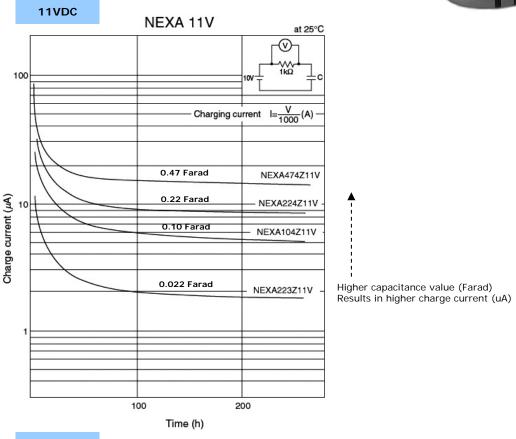


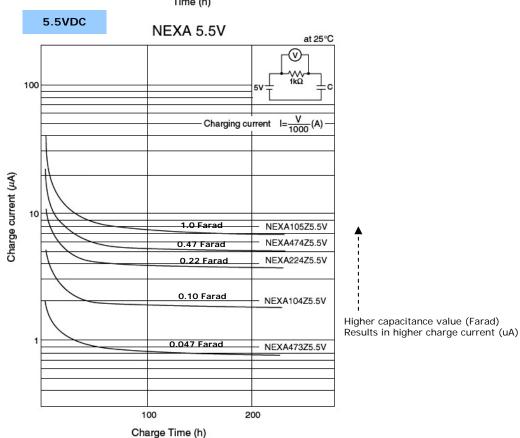
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Charge Current over Time



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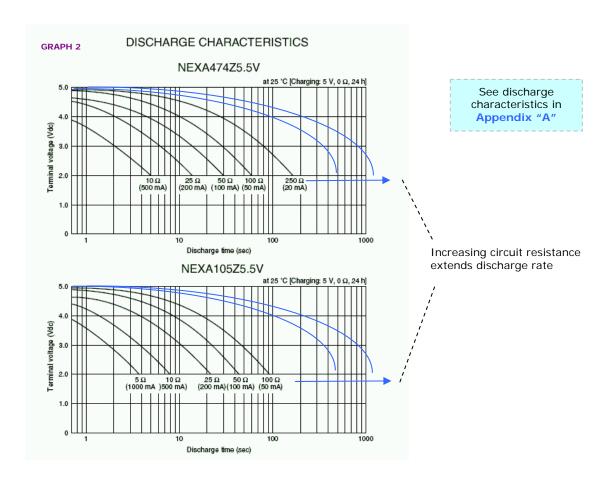
PN: NEX_ series & NED_ series

2.0 Discharge Rate (via connecting circuitry)

The rate of discharge of double layer capacitors will be determined by the resistance of connecting circuitry (GRAPH 2).

Discharge Tips:

- Increasing circuit resistance extends discharge rate
- o Longer charging time will extend discharge rate



3.0 Voltage Holding Characteristic (self-discharge)

Self-discharge of double layer capacitors is characterized via the "Voltage Holding Characteristic" as shown on specification sheets, and specifies the minimum voltage after 24 hours at room temperature after the part has been charged for 24 hours at the rated voltage.

Example: NEXG and NEXC series for power back-up applications:

Holding Voltage = **4.2VDC** (for 5.5VDC rated components) is the minimum voltage on the capacitor after 24 hours charge at 5.5VDC, followed by 24 hour period $(+25^{\circ}C)$ with no circuitry load resistance applied.

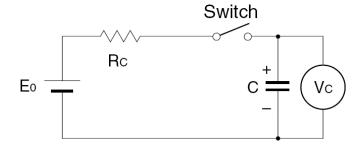
PN: NEX_ series & NED_ series

4.0 Capacitance Value

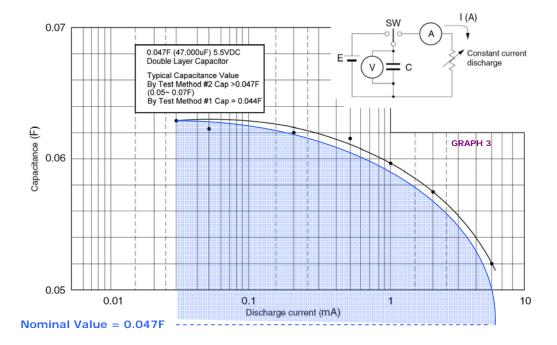
Due to the very large capacitance and relatively high ESR of double layer capacitors the capacitance value cannot be measured using standard capacitance meters. Two methods are used to determine the capacitance value of double layer capacitors:

Charging Method:

- 1. Constant resistance charge method Capacitance value test
 - o Prep component by shorting terminals for 30 minutes prior to capacitance value test
 - Capacitance (F) is calculated by measuring the time constant (t) until capacitor voltage reaches 0.632 of applied VDC (Eo)
 - o Rc is fixed resistance value
 - Capacitance (Farads) = t/Rc



- 2. Constant current charge discharge method Capacitance value test
 - o Test method similar to common circuit application
 - As discharge current increases the capacitance value will decrease as shown in example helow
 - o Note: At low discharge currents the capacitance value may be 130 ~ 150% of nominal value, as shown in below graph (graph 3)



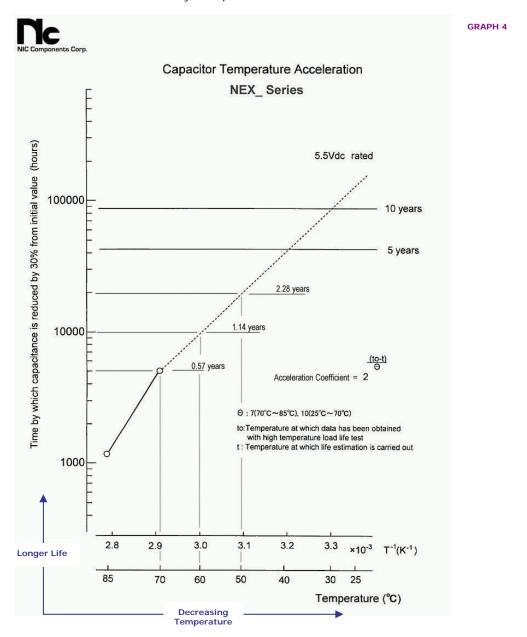
5.0 Life Time

Double layer capacitors, much like aluminum electrolytic capacitors, have a limited service life, as electrolyte will dissipate over time (and operating temperature) from the component, resulting in component wear-out. Lifetime estimation will be chiefly governed by operating temperature and can be estimated from graph "Capacitor Temperature Acceleration" (GRAPH 4). Lifetime is defined as point at which capacitance value is reduced by 70% of the initial capacitance value.

Failure mode of double layer capacitors is "open" mode under normal conditions, but short-circuit may result if extreme voltage, exceeding the maximum operating voltage is applied to the component. Water vapor, generated from water within the electrolyte (dilute sulfuric acid), gradually dissipates from the component in from of gas and is not dangerous. However, if unusual voltage such as greater than the maximum operating voltage is applied suddenly, leakage of liquid electrolyte or rupturing of component may result. When used for long periods at high operating temperature, the moisture of the electrolyte evaporates and the equivalent series resistance (ESR) increases. The fundamental failure mode is the open mode with ESR increase.

When using these capacitors, incorporate appropriate safety measures in your design, such as redundancy and protection measures.

Failure Rate- FIT: FIT rate for double layers capacitors is estimated to be 0.06 FIT

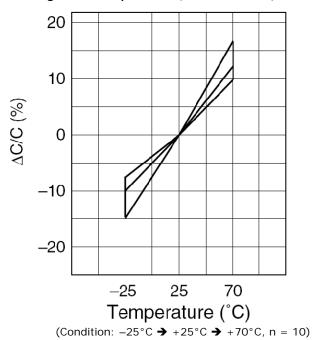


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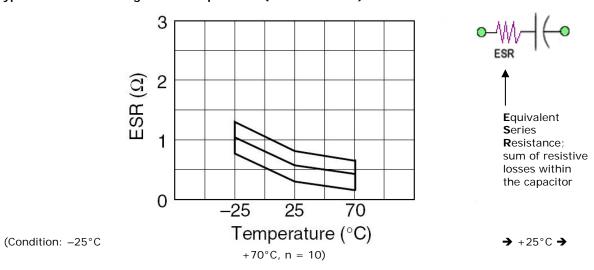
6.0 Temperature Characteristics:

Typical Capacitance Change over Temperature (-25°C ~ +70°C)



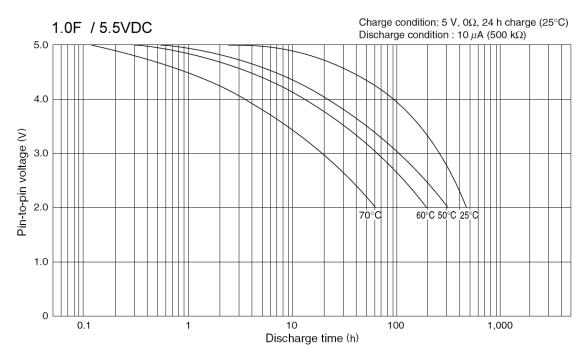
SUMMARY: Increased capacitance as temperature increases

Typical 1KHz ESR Change over Temperature (-25°C ~ +70°C)



SUMMARY: Decreasing ESR as temperature increases

Typical Discharge Characteristics over Temperature (+25°C, +50°C, +60°C & +70°C)



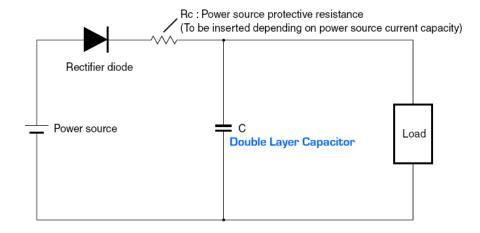
SUMMARY: Decreasing charge as temperature increases

Circuit Applications:

Primary Use:

Backup power source circuits for electric circuit operations and data preservation of microcomputers and memory devices during the power source interruption.

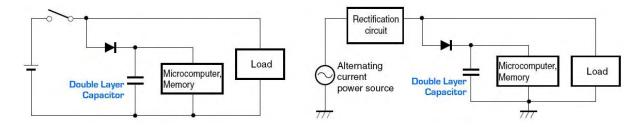
- Power failure, unplugging, operation error interruption
- Shock or unstable connection to primary power source (line or battery)
- · Lack of sunlight on solar battery
- Anticipated power down reboot restart
- Changing of battery interruption



Power source of the memory component is backed up for period of time so that data preserved in memory is not lost.

Examples of products employing backup circuits:

- · Measurement & Control systems
- Telephone equipment
- Audio Video equipment
- Communication equipment
- Transportation
- · Office automation equipment
- · Smart metering monitoring equipment



Circuit Applications:

Power Failure Display Lighting

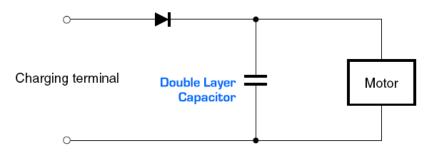
Lighting of lamp or LED during power failure or when power source is off, gradually darkening after a certain time.

Motor Drive

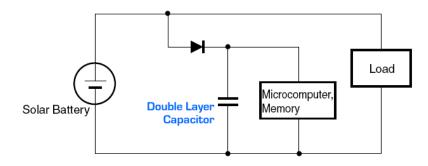
Heavy load, stepped load or boost discharge applications:

Double layer capacitor provides instantaneously power to memory and electronic circuits, for low power source capacity and initiating initial torque.

- HDD
- Motors
- Printers
- · Relays

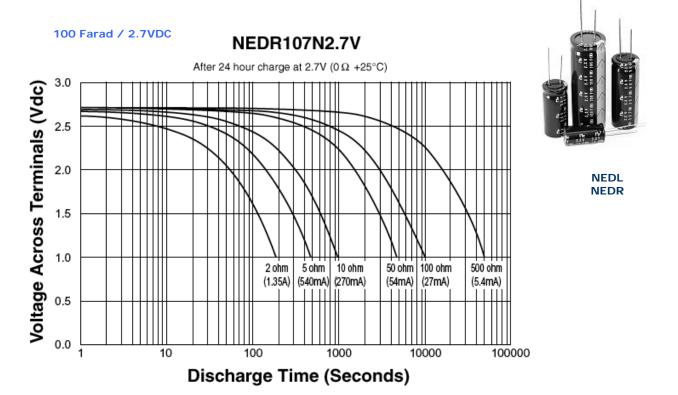


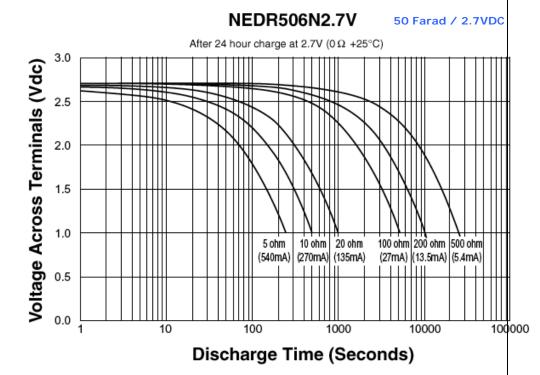
Solar Battery Back-up



APPENDIX "A"

RE: Double Layer Capacitors

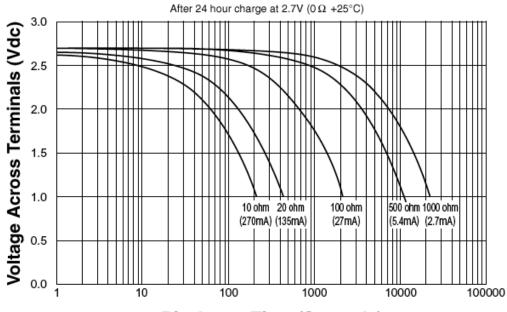




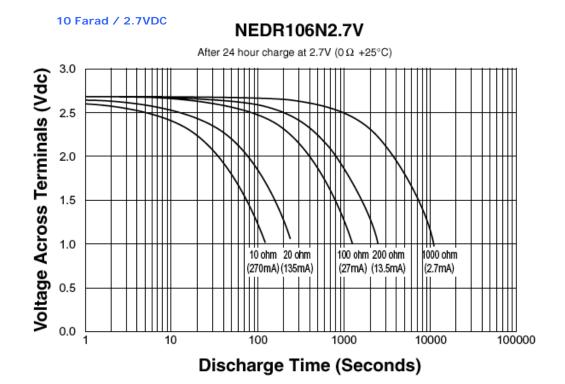
Constant Resistance Discharge Characteristics

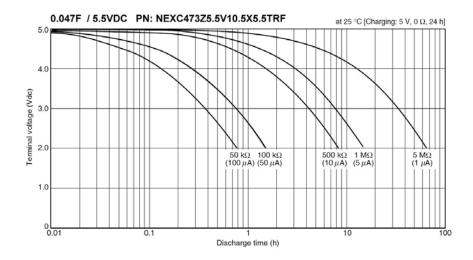
22 Farad / 2.7VDC

NEDR226N2.7V



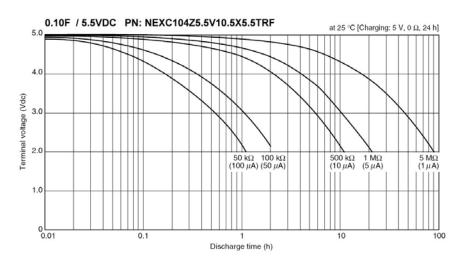
Discharge Time (Seconds)

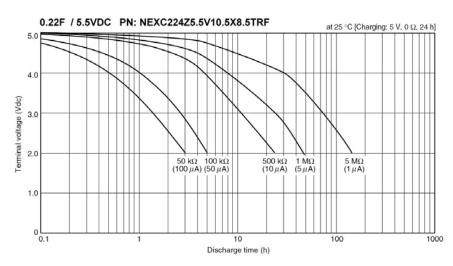


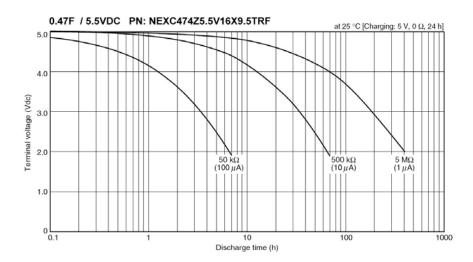


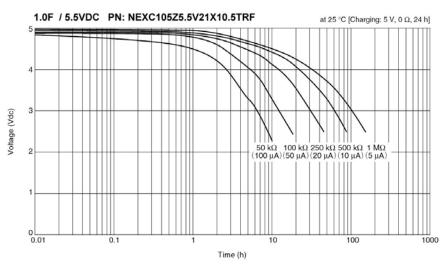


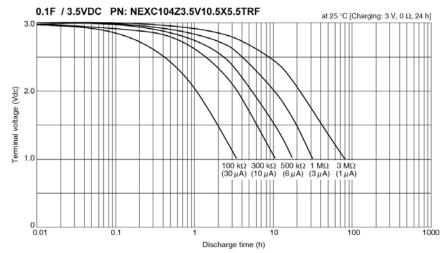
NEXC











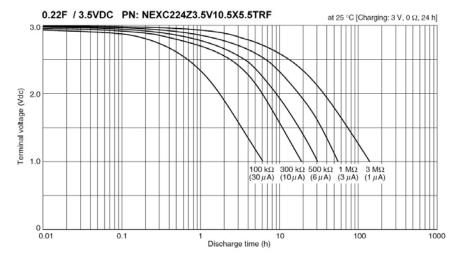


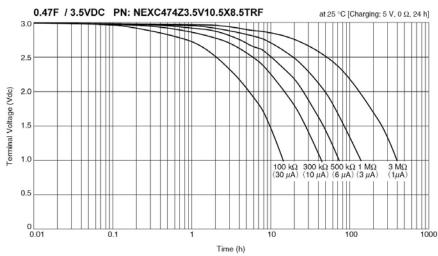
NEXC

RE: Double Layer Capacitors



NEXC

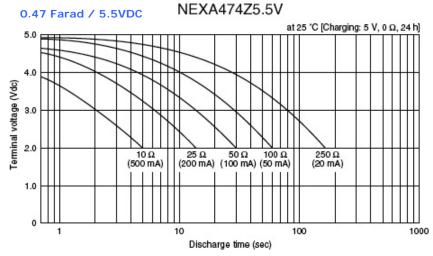


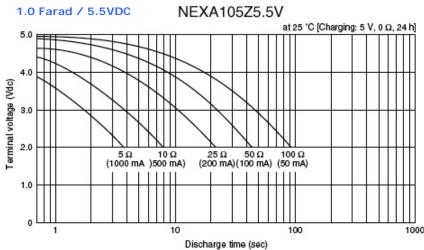


Constant Resistance Discharge Characteristics

DISCHARGE CHARACTERISTICS







RE: Double Layer Capacitors



